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# **SOD-323 Plastic-Encapsulate Diode**

## **PRODUCT SUMMARY**

RB551V-30 Schottky Diodes

#### **FEATURES**

High current rectifier Schottky diode Low voltage, low inductance For power supply

MARKING: D





#### MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Single Diode @ T<sub>A</sub> = 25°C

Parameter	Symbol	Limits	Unit
Peak reverse voltage	V <sub>RM</sub> 30		V
DC reverse voltage	$V_R$	20	V
Mean rectifying current	Io	0.5	А
Peak forward surge current	I <sub>FSM</sub>	2	А
Junction temperature	T <sub>j</sub>	125	℃
Storage temperature	T <sub>stg</sub>	-40~+125	℃

## **ELECTRICAL RATINGS**

@  $T_A = 25^{\circ}C$ 

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward voltage	V <sub>F</sub>			0.36		I <sub>F</sub> =100mA
				0.47	V	I <sub>F</sub> =500mA
Reverse current	I <sub>R</sub>			100	μΑ	V <sub>R</sub> =20V



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#### TYPICAL CHARACTERISTICS

Electrical Characteristic curves (T<sub>a</sub> = 25°C)

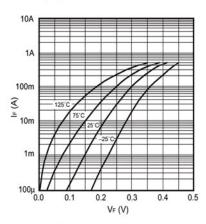


Fig.1 Forward characteristics

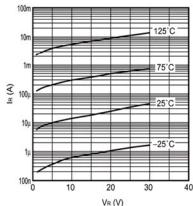


Fig.2 Reverse characteristics

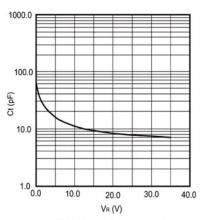


Fig.3 Capacitance between terminals characteristics

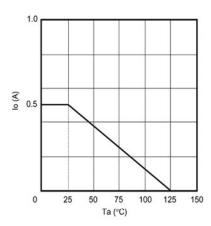


Fig.4 Derating curve

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